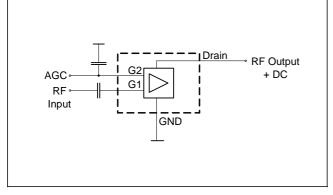


# BF1005S...

#### Silicon N-Channel MOSFET Tetrode

- For low noise, high gain controlled input stages up to 1 GHz
- Operating voltage 5 V
- Integrated biasing network
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Package	Pin Configuration						Marking
BF1005S	SOT143	1=S	2=D	3=G2	4=G1	-	-	NZs
BF1005SR	SOT143R	1=D	2=S	3=G1	4=G2	-	-	NZs

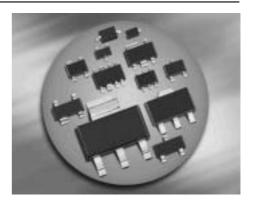
#### **Maximum Ratings**

Symbol	Value	Unit	
V <sub>DS</sub>	8	V	
I <sub>D</sub>	25	mA	
± <i>I</i> <sub>G1/2SM</sub>	10		
+V <sub>G1SE</sub>	3	V	
P <sub>tot</sub>	200	mW	
T <sub>stg</sub>	-55 150	°C	
T <sub>ch</sub>	150		
	$V_{DS}$ $I_{D}$ $\pm I_{G1/2SM}$ $+ V_{G1SE}$ $P_{tot}$ $T_{stg}$	$V_{DS}$ 8 $I_D$ 25 $\pm I_{G1/2SM}$ 10 $+V_{G1SE}$ 3 $P_{tot}$ 200 $T_{stg}$ -55 150	

<sup>1</sup>Pb-containing package may be available upon special request

Note:

It is not recommended to apply external DC-voltage on Gate 1 in active mode.





#### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Channel - soldering point <sup>1)</sup>	R <sub>thchs</sub>	≤ 370	K/W

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values			Unit	
			typ.	max.	1	
DC Characteristics			•	•	•	
Drain-source breakdown voltage	V <sub>(BR)DS</sub>	12	-	-	V	
$I_{\rm D} = 650 \ \mu {\rm A}, \ V_{\rm G1S} = 0$ , $V_{\rm G2S} = 0$						
Gate1-source breakdown voltage	+V <sub>(BR)G1SS</sub>	8	-	12		
$+I_{G1S} = 10 \text{ mA}, V_{G2S} = 0, V_{DS} = 0$						
Gate2 source breakdown voltage	±V <sub>(BR)G2SS</sub>	8	-	13		
$\pm I_{G2S} = 10 \text{ mA}, V_{G1S} = 0, V_{DS} = 0$						
Gate1-source leakage current	+I <sub>G1SS</sub>	-	100	-	μA	
$V_{G1S} = 6 V, V_{G2S} = 0$						
Gate 2 source leakage current	±I <sub>G2SS</sub>	-	-	50	nA	
$\pm V_{G2S} = 8 \text{ V}, V_{G1S} = 0 \text{ , } V_{DS} = 0$						
Drain current	I <sub>DSS</sub>	-	-	800	μA	
$V_{\text{DS}} = 5 \text{ V}, \ V_{\text{G1S}} = 0 \ , \ V_{\text{G2S}} = 4 \text{ V}$						
Operating current (selfbiased)	I <sub>DSO</sub>	8	13	16	mA	
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V}$						
Gate2-source pinch-off voltage	V <sub>G2S(p)</sub>	-	1	-	V	
$V_{\rm DS} = 5 \text{ V}, I_{\rm D} = 100 \mu\text{A}$						

<sup>1</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note Thermal Resistance

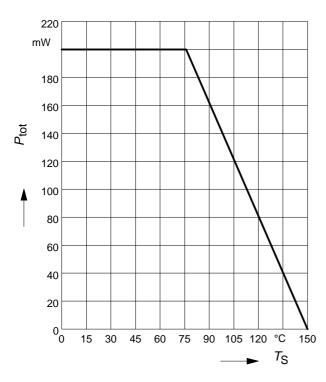


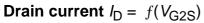
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sa	ampling)				
Forward transconductance	g <sub>fs</sub>	26	30	-	mS
$V_{\rm DS} = 5 \text{ V}, \ V_{\rm G2S} = 4.5 \text{ V}$					
Gate1 input capacitance	C <sub>g1ss</sub>	-	2.4	2.7	pF
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V}, f = 1 \text{ MHz}$	-				
Output capacitance	C <sub>dss</sub>	-	1.3	-	
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V}, f = 100 \text{ MHz}$					
Power gain (self biased)	Gp	20	22	-	dB
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V}, f = 800 \text{ MHz}$					
Noise figure	F	-	1.6	2.1	dB
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V}, f = 800 \text{ MHz}$					
Gain control range	$\Delta G_{p}$	40	50	-	
$V_{\text{DS}} = 5 \text{ V}, V_{\text{G2S}} = 4 \text{ V} \dots 0 \text{ V}, f = 800 \text{ MHz}$					

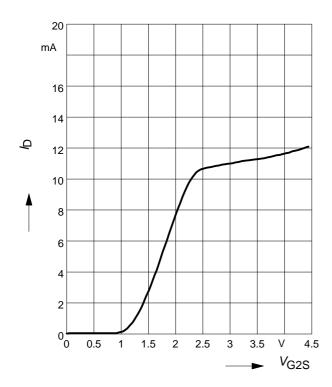
# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified



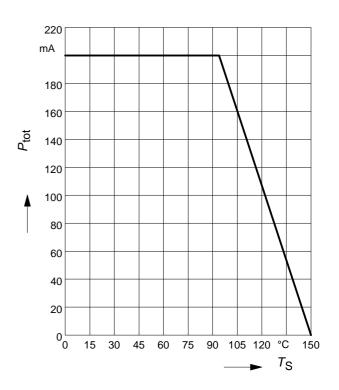
Total power dissipation  $P_{tot} = f(T_S)$ BF1005S, BF1005SR



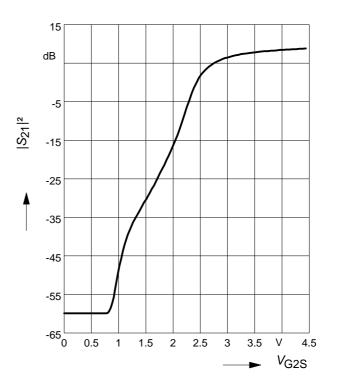




Total power dissipation  $P_{tot} = f(T_S)$ BF1005SW



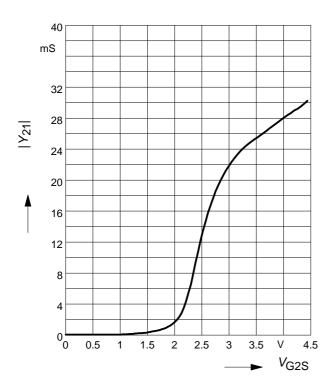
Insertion power gain  $|S_{21}|^2 = f(V_{G2S})$ 



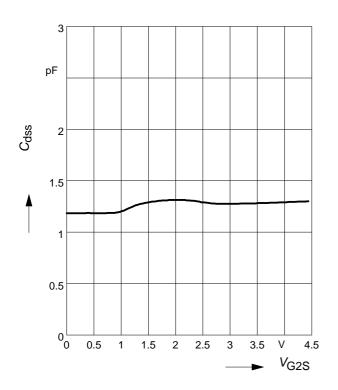


Forward transfer admittance

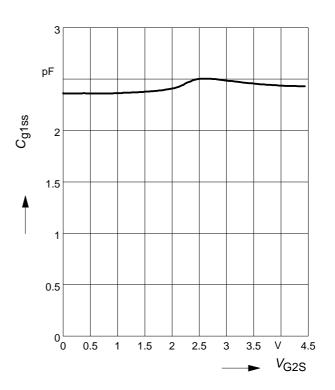
 $|Y_{21}| = f(V_{G2S})$ 



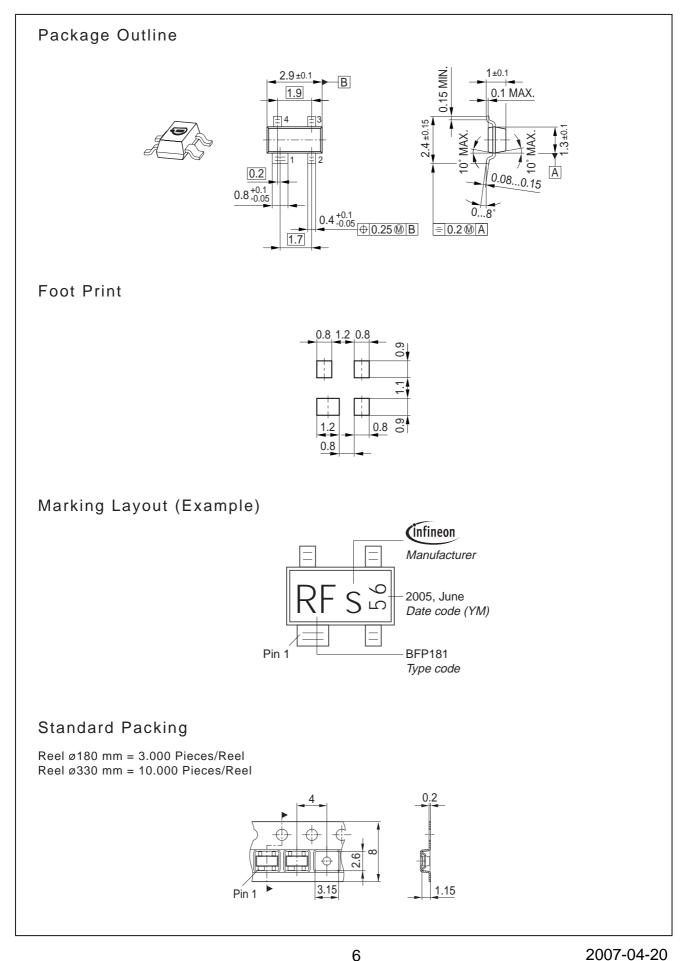
**Output capacitance**  $C_{dss} = f(V_{G2S})$ f = 200 MHz



Gate 1 input capacitance  $C_{g1ss}=f(V_{g2s})$ f = 200MHz





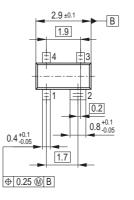


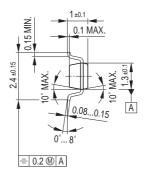


# Package SOT143R

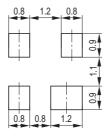
### Package Outline



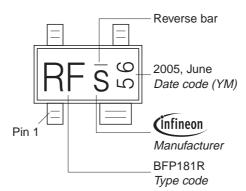




# Foot Print

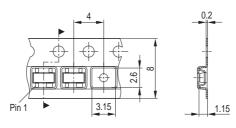


### Marking Layout (Example)



# Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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